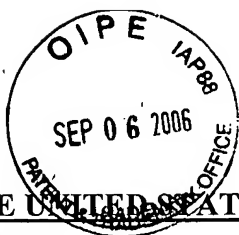


S/N 10/675,921



PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Yin Men Lai et al.

Examiner: Chris Chu

Serial No.: 10/675,921

Group Art Unit: 2815

Filed: September 30, 2003

Docket: 884.A65US1

Title: CAPILLARY UNDERFILL AND MOLD ENCAPSULATION METHOD AND  
APPARATUS

Assignee: Intel Corporation

Customer Number: 21186

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RESPONSE TO RESTRICTION REQUIREMENT

MS Amendment

Commissioner for Patents

P.O. Box 1450

Alexandria, VA 22313-1450

This paper responds to the Restriction Requirement mailed on August 8, 2006.